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Tailored surface chemistry of SiO₂ particles with improved rheological, thermal-mechanical and adhesive properties of epoxy based composites for underfill applications

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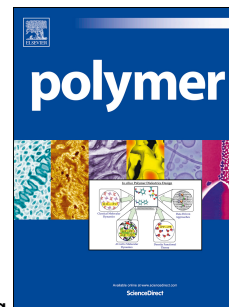
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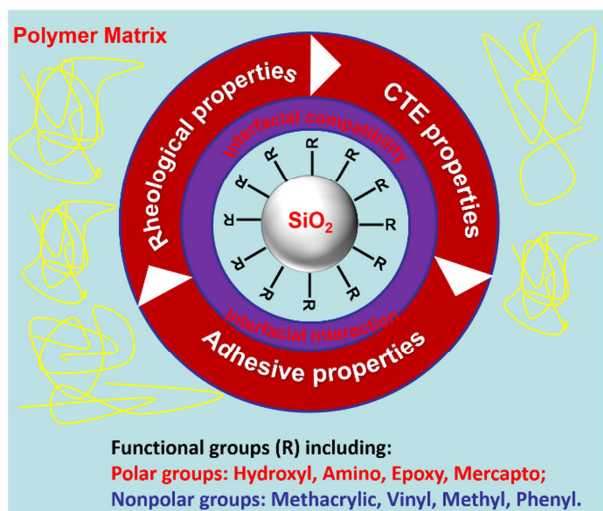
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